# **Quad 2-Input OR Gate**

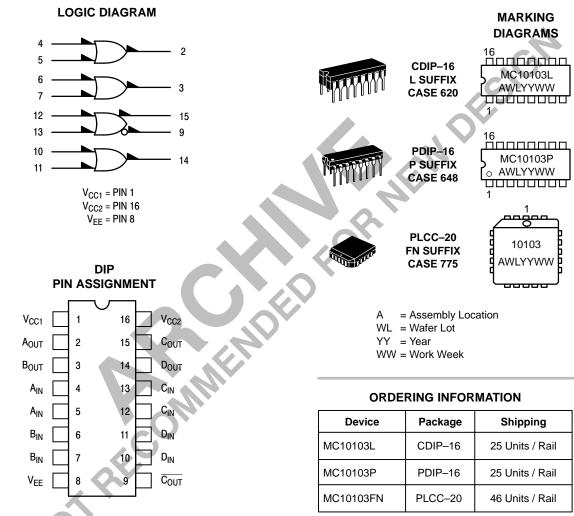
The MC10103 is a quad 2-input OR gate. The MC10103 provides one gate with OR/NOR outputs.

- $P_D = 25 \text{ mW typ/gate}$  (No Load)
- $t_{pd} = 2.0 \text{ ns typ}$
- $t_r$ ,  $t_f = 2.0$  ns typ (20%-80%)



## **ON Semiconductor**

http://onsemi.com



Pin assignment is for Dual–in–Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

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#### **ELECTRICAL CHARACTERISTICS**

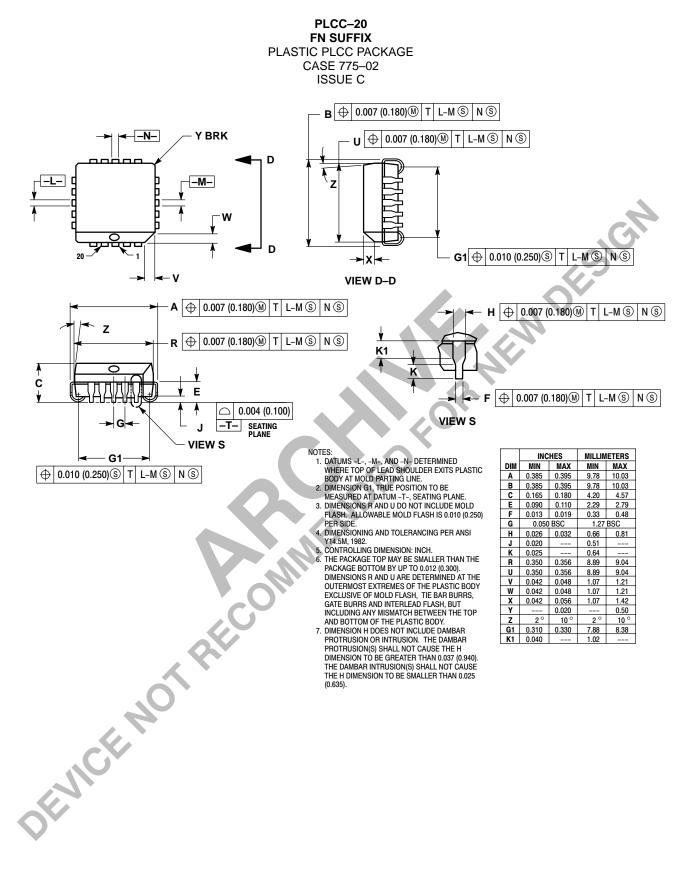
Characteristic Power Supply Drain Current Input Current Output Voltage Logic		Pin	Test Limits           -30°C         +25°C         +85°C							-
Power Supply Drain Current Input Current		Under		T	+25°C		T		+85°C	
Input Current	Symbol	Test	Min	Max	Min	Тур	Max	Min	Max	Uni
-		8		29		21	26		29	mAc
Output Voltage Logic	I <sub>inH</sub>	4*		390			245		245	μΑσ
Output Voltage Logic	I <sub>inL</sub>	4*	0.5		0.5			0.3		μAd
		2 9	-1.060 -1.060	-0.890 -0.890	-0.960 -0.960		-0.810 -0.810	-0.890 -0.890	-0.700 -0.700	Vde
Output Voltage Logic (	) V <sub>OL</sub>	2 9	-1.890 -1.890	-1.675 -1.675	-1.850 -1.850		-1.650 -1.650	-1.825 -1.825	-1.615 -1.615	Vde
Threshold Voltage Logic 7	V <sub>OHA</sub>	2 9	-1.080 -1.080		-0.980 -0.980			-0.910 -0.910		Vd
Threshold Voltage Logic (	) V <sub>OLA</sub>	2 9		-1.655 -1.655			-1.630 -1.630		-1.595 -1.595	Vde
Switching Times (50 $\Omega$ Load	)								5	ns
Propagation Delay	t <sub>4+2+</sub> t <sub>12+9–</sub>	2 9	1.0 1.0	3.1 3.1	1.0 1.0	2.0 2.0	2.9 2.9	1.0 1.0	3.3 3.3	
Rise Time (20 to 80%	) t <sub>2+</sub>	2	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
Fall Time (20 to 80%		2	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
DEMICEN	51 PA	C C								

#### ELECTRICAL CHARACTERISTICS (continued)

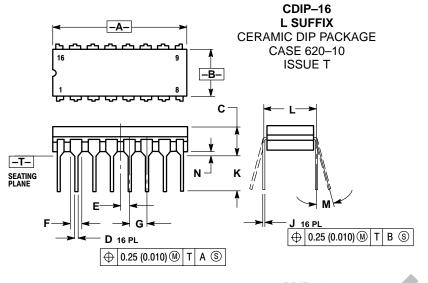
		TEST VOLTAGE VALUES (Volts)							
		@ Test Te	mperature	V <sub>IHmax</sub>	V <sub>ILmin</sub>	V <sub>IHAmin</sub>	V <sub>ILAmax</sub>	V <sub>EE</sub>	
			–30°C	-0.890	-1.890	-1.205	-1.500	-5.2	
			+25°C	-0.810	-1.850	-1.105	-1.475	-5.2	
			+85°C	-0.700	-1.825	-1.035	-1.440	-5.2	
Pin			TEST V	OLTAGE AP	PLIED TO P	INS LISTED I	BELOW	<i></i>	
Character	Symbol	Under Test	V <sub>IHmax</sub>	V <sub>ILmin</sub>	V <sub>IHAmin</sub>	V <sub>ILAmax</sub>	V <sub>EE</sub>	(V <sub>CC</sub> ) Gnd	
Power Supply Drain	Current	Ι <sub>Ε</sub>	8					8	1, 16
Input Current		l <sub>inH</sub>	4*	4*				8	1, 16
		I <sub>inL</sub>	4*		4*			8	1, 16
Output Voltage	Logic 1	V <sub>OH</sub>	2 9	4.5				8 8	1, 16 1, 16
Output Voltage	Logic 0	V <sub>OL</sub>	2 9	12, 13				8 8	1, 16 1, 16
Threshold Voltage	Logic 1	V <sub>OHA</sub>	2 9			4, 5	12, 13	8 8	1, 16 1, 16
Threshold Voltage	Logic 0	V <sub>OLA</sub>	2 9			12, 13	4,5	8 8	1, 16 1, 16
Switching Times	(50 $\Omega$ Load)					Pulse In	Pulse Out	–3.2 V	+2.0 V
Propagation Delay		t <sub>4+2+</sub> t <sub>12+9–</sub>	2 9			4 12	2 9	8 8	1, 16 1, 16
Rise Time	(20 to 80%)	t <sub>2+</sub>	2			4	2	8	1, 16
Fall Time	(20 to 80%)	t <sub>2-</sub>	2			4	2	8	1, 16

<text> Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the

#### PACKAGE DIMENSIONS



#### PACKAGE DIMENSIONS



NOTES:

DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.
 DIMENSION L TO CENTER OF LEAD WHEN FOOMED DRAWLES

FORMED PARALLEL. 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
Е	0.050 BSC		1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100 BSC		2.54 BSC		
Н	0.008	0.015	0.21	0.38	
κ	0.125	0.170	3.18	4.31	
Г	0.300	BSC	7.62 BSC		
Μ	0 °	15 °	0 °	15°	
Ν	0.020	0.040	0.51	1.01	

-A-<u>ሳ ስ ስ ስ</u> 16 в 0 L  $\Box \Box$ ι, հո - C S -T- SEATING PLANE H G **D** 16 PL

PDIP-16 **P SUFFIX** PLASTIC DIP PACKAGE CASE 648-08 ISSUE R

NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL. 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH. 5. ROUNDED CORNERS OPTIONAL

		INC	HES	MILLIMETERS		
	DIM	MIN	MAX	MIN	MAX	
	Α	0.740	0.770	18.80	19.55	
	В	0.250	0.270	6.35	6.85	
	С	0.145	0.175	3.69	4.44	
L	D	0.015	0.021	0.39	0.53	
Γ	F	0.040	0.70	1.02	1.77	
	G	0.100	BSC	2.54 BSC		
	Н	0.050	BSC	1.27 BSC		
	J	0.008	0.015	0.21	0.38	
	Κ	0.110	0.130	2.80	3.30	
Γ	L	0.295	0.305	7.50	7.74	
	М	0°	10 °	0 °	10 °	
L	S	0.020	0.040	0.51	1.01	

# **Notes**

DEWCE NOT RECOMMENDED FOR MENDESIGN

# **Notes**

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